

INDEX TO VOL. 30 (1988)

AA spectruphotometer AAAS national meeting	1,29
	2 30
Acoustic blade monitor Acoustic scanner Actinides Advanced Composites Mtrls.	12,30 10,96 4,68 8,23
Advanced photon source Advanced tactical fighter Advanced Tech. Mtrls. Inc. 1 Aerosol process	9,47 5,65 0,91 0,23
Aircraft industry Air Force Flight Dynamics Laboratory	5,40 2,15 0.83
Agriculture, Dept. of Al-based translation Air pollution	3,37 1,92 1,67 3,29
Aircraft incidents Allied-Signal Inc. Alloy systems Alternating eclipses Alternative energy	6,5. 6,43. 7,97
Aluminum & Chemical Corp. Aluminum alloys Aluminum Co. of America 16 Aluminum coating process 16	,84.
Amax Inc. 18 American Trade Corp 5	1.83.
Amoco Corp. Amorphous metals Amorphous silicon Amorphous silicon Amorphous thermoplastics Amorphous thermoplastics	,52. ,50.
Analyte Corp. Analytical instruments 7,18; 8 Anisotropic etching 4,49;5 Annual salary 8;	,62. ,13. ,97.
Antireflective lens coat 2 Antirust laws 6,17 Apolar-polar interaction 18 Applied Science & Technology II	,49. ,88. ,63. ,56.
Applied science 3,36; 7, Argonne National Lab 10, 75,76	92. 11. 66. 99.
Artificial intelligence 4,67; \$, Artificial vision 5, Aspheric lenses 4, Asynchronous communication	23. 00. 47. 47. 35.
ASYST software 2,10 AT&T Bell Laboratories 10,76, 80,10	
Atomic force probe Atomication process Attachment/algorithm-NIR Auger electron spectroscopy 5,8	37.
Australian research Automated chemistry Automation Research Center 2, Automobile accidents Autonomous robot 1,2	3.
B Backscattered-electron detector	
Background conductivity Balance of trade 3,9; 7,11,4 Basic manufacturing proc. 2,7; Basic research 7,1; Battelle Memorial Institute 3,3;	3. 5. 5.
Battelle Technology Intl. 3,31 Battery systems 9,48; 12,22 Baxter Healthcare Corp. 10,72 Bee migration 8,12 Begats, case of 12,57 Beryllium monitor 16,03	5.
Bhopal, India 11,20 Big Bang 5,34	

and be a compared and					
and becomply an interval and becomply and an interval and applications of the properties of the proper			Bold typ	1 96	elers to issue numbers
Commercial promise 2,68. Draper Prize 100,000 mthus 100,000 mth	317.35.1.1.1.1.1.1.1.1.1.1.1.1.1.1.1.1.1.1.	Binary gas mixtures systems biocatalytic membrane biocatalytic membrane biocatalytic membrane biocatalytic membrane biocatalytic membrane biologic surfactant Biological particles Biologic surfactant Biological particles biomaterials biomat	7.7.9.9.18.18.19.19.19.19.19.19.19.19.19.19.19.19.19.	20.086.88.5.02.27.7.11.11.11.11.11.11.11.11.11.11.11.11.	Commercial space Communications a 3,31 Communications a 4,31 Competitive challenge Competitive challenge Competitive disadvant Compositive standard a 4,31 Compositive challenge Computer designs Computer des designs Computer des
Commercial promise 7,58. Dwarf star Dynamic recrystallization	CC	omets	6,34.	Dr	ive-by-wire automobile
		ommercial aircraft ommercial promise	7 ,58. 8 ,13.	Di	varf star

7,	20. Commercial space 4,41; 8,2	0. Dynamic-range enhancing 8,5
9, 10,	36. Communications 3,31; 4,88; 5,6	8.
10,	95. Compacting compilers 4 9	E E
10,	SZ. Compension 19-74	4 F-hearn electrorellactures 48 400
4	57. Competitive challenge 6.6.	3. Earth's atmosphere 6,34
1.	5.7 Competitive challenge 6.6 Competitive disadvantage 1.2 Competitive disadvantage 1.2 Competitive disadvantage 1.2 Competitive disadvantage 1.2 Competitiveness 3,39; 4,47 6.1 Composites 1,81; 8,524; 9,44 1.2 Composites 1,81; 8,524; 9,44 1.3 11.3 Compound semiconductors 4,32 Computer designs 9.2 Computer disadvantage 1.3 Comput	3. Earth's atmosphere 6,3/ 3. Earth's crust 2,38 1. Earth's magnetic field 7,21
1,56; 11,	72.	3. Earthquake 1,35; 12,25
	57. Competitiveness 3,39; 4,47; 6,1; 68.	7; Economic benefits 4,47
1.	41 Composites 1.81-8.5.24-9.40	7. Economic bridges 7,75 3; Economic incentive 6,11
1,	29. 10.13: 11.3:	Economic incentive 6,11 Economic issues 7,44
5,4	47. Compound semiconductors 4,35	5. Economic outlook 1.46
11,3		
2,6	31. Computer graphics 1,43 26. Computer literacy 2,120 27. Computer metworks 11,29 20. Computer seturol 3,33 20. Computer simulation 2,41 5,45	B. Economic success 8,81 Economic ties 2,43
9,8	32. Computer modeling 2.60	1. Economic ties 2,43 1. Economic vitality 2,37
10,7	73. Computer networks 11,29 20: Computer Security Act 3,36	Economic vitality 2,37. Eddy current device 8,25.
2,12 6,10	3. Computer simulation 3,41; 5,45	Editorial Board 6,23: 10,7 Education quality 3,39: 12,11 Education system 2,120 EDX spectrometer 5,84,92
2,4	14. 7.58	Education system 2 120
5,4	Id. Computer-aided planning 2.73	EDX spectrometer 5,84,99
9,2 1,34; 8,2 s 10,7 1,2	5. Computer viruses 11,3; 12,33 0. Computerized car 3,41	
s 10,7	O. Computerized car 3,41 9. Computing power 4,70	Elastomeric polypeptide 8,57;
1,2	9. Condensible vapors B.E.	10.7.56
92,10	t, comporting hothings	. I Croutifu Power riesearch inst.
3,4		Electrical current 10,95,96.
10.6	8. Contamination evaluator 10 153	Electrical discharges # 27
10,	3. Continental Laser Corp. 10,100.	Electrical equipment 4,92 Electrical field 8,25,50
32	O. Continuous reactor 4,99 Continuous recrystallization 7,22	Electrical field 8,25,50.
- Oliv	Continuous wave operation 1,61.	Electrical registration 5'90'
	Contract research 9,13.	Electro-optic integrated circuit
10.4	Conversion coating system 10,92.	18 7C
1,23,46	Conner compleyes 9.47	Electro-rheological fluid 9.3. Electrode configuration 7,63.
1,23,46	5. Corporate profits 1,46,49. Corrosion-induced fatigue 4,52.	Electromagnetic fields 2,108
12,3 port 2,76	6. Corporate profits 3. Corrosion-induced fatigue 4,52 Cosmic Cube Counterflow architecture 3,75.	Electromagnetic launcher 2 40
10.79	Cosmic Cube 9,56. Counterflow architecture 3,75.	Electromagnetic vibration 9,187. Electromagnetic cage 7,3.
10,79	CPM 11.54	
8,22	5. CPM 11,54. 2. Crack growth 8,25. 3. Creep-free anode 2,76. 5. Crusades 9,63.	Electron beams 12,85. Electron beam ion trap 7,3; 9,44.
6.76	Crusades 2,76.	Electron beam ion trap 7,3; 9,44.
6,76 2,76		Electron energy spectrum 7 21
2,38 5,33	Crystal prientations 1 61 6 76	
		Electron optics column 9,112
18 92	Cyanide determination 2,126.	Electron spectroscopy 9,120. Electron spin resonance 2,63.
35; 2,33	2,120.	Electron storage ring 6 143
35; 2 ,33 4; 11 ,85 4 ,27	-	Electron-beam scattering 9,112.
5.46		Electronic Systems Technology
68; 7,22	Data acquisition 2,100; 3,70; 5,68,76; 7,58. Database 10,44.	Electron spin resonance 2,63. Electron storage ring 6,143. Electronics am scattering 9,112. Electronics industry 10,74. Electronics industry 10,74. Electrospray ionization 10,67. Emerging technologies 2,55.44:
	6,68,76; 7,58.	Electrospray ionization 10.67.
7.18.44	Database 10,44. Decarburization 5.84	Emerging technologies 7,25,44;
7,18,44	Decarburization 5,84. Deceleration process 4.15.	Employe-inventors 9,26. Employment opportunies 2,29;
10,100.	Defense contractors 7.25	Employment opportunies 2,29:
tromete:	Defense network 3,29.	8.19
9,31.	Defense production 10,23. Defense spending 8,19.	Encoding time 3,37. Energy infrastructure 5,68.
8,14. 4,15.	Defense spending 0,19. Defense technology 1,37. Deficit reduction 1,46.	Energy shortages 9,3.
4,15.	Delicit reduction 1.46.	Energy storage 4 52
8,33.	Delta vacuum chamber 7,97. Deposition stations 4,99	Energy transport 2,33.
4,88.	Design liability 10,50.	Energy conservation 5,68. Engine design 5,40.
uction		FROMBeering adjugation \$ 20- 9-44
8,57. 8,57.		Engineering plastics 9,187. Engineering Research Center 4,47;
11,20. 12,227; 4,52. 10,73. 7,58. 4,35.	Diamond material 7,3. Diamond thin-film source 10,92. Diamond turning machine 4,35. Die-casting methods 3,48.	Engineering Research Center 4,47;
; 2,227;	Diamond turning machine 4,35.	Entrepreneur 1,9; 4,74; 8,11. Environmental protection 5,17; 9,32.
10 73		Environmental protection 5,17;
7,58.	Digital imaging 5,92 Digital microwave 2,68	Environmental SEM 9,32.
4,35.	Digital tactile sensor 6.3	Erect-field spectrometer WA AJ
	Unneen, Gerald 10 3 1	ESUA 237 I
9,3. 7,3. 3,50.	Diode array detector 10,67. Disk bandwidth 6,68.	Espionage activities 6,33; 7,25.
3,50.	Display bandwidth 6,68.	Ethylene supply 10,28.
1,41. 3,50.	UNA amplification system 10 73	2.78
3,30.		European research 5,39; 11,30.
3 AR	DOC-Pentagon rivalry 4,40 Dopant uniformity 4,99	European space agency 1,33;
7,63.		Eunondoble level
7,63. 3; 9, 25.	Dortmund, Univ. of 10,66.	experioable launch 1 33 1
7,63. 3,9,25. 3,37.	Double planet 3,43.	Experimental fusion reactor 2,78
9,74.	Dow Chemical Co. 10,79.	Ethylene supply European Conomic Community 2,78. European research 5,39; 11,30. European space agency 1,33. European space agency 6,22. Expendable launch 2,38. Experimental fusion reactor 2,78. Explosive bonding 1,27.
9,74.	Dow Chemical Co. 10,79. Draper Prize 12,3. Drive-by-wire automobile 3,41	Explosives detector 10 %
9,74. 2,68. 10,123. 6.34.	Dow Chemical Co. 10,79. Draper Prize 12,3. Drive-by-wire automobile 3,41	Explosives detector Export licensing 7,21; 10,24. Extended Duration Orbiter 7,35
7,63. 3; 9,25. 3,37. 9,74. 2,68. 10,123. 6,34. 7,58. 8,13.	Dow Chemical Co. 10,79.	explosives detector ## ##

0.	E		Hazardous wasts
5.5. Free Free Free Free Free Free Free Fre	cture imitations cture mechanics e energy of interaction ezing sex cells nch researchers quency mixing system Intl. Inc. R spectrometers 2,6	10,7;44,7;44,7;44,4;35,44,7;44,4;35,44,4;49,47;44,49,47,49,47;44,49,47,49,47;44,49,47,49,47,49,47,49,47,49,47,49,47,49,47,49,47,49,47,49,47,49,47,49,47,49,47,49,47,49,47,49,47,49,47,4	Helium leak detectors 3,75. Helium-nean laser 1,8,80. Helium-lean laser 1,8,80. Hetrinck Scientific 1,8,80. Hetrinck Scientific 1,8,80. Help Lethology groots 2,45,8,18. High Lethology firms 7,25, 8,18. High Lethology firms 7,25, 8,18. High-eurent conductor 7,25, 8,18. High-ensistivity coalings 1,52. High-ensistivity coalings 1,52. High-ensistivity coalings 1,52. High-performance aircraft 1,55,56. High-performance aircraft 2,94. High-pressure heat 2,94. High-pressure heat 2,94. High-speed amplifiers 9,96. High-stength alloys 7,22. High-tech salaries 1,99. High-tech salaries 1,99. High-tech salaries 2,99. High-tech salaries 2,99. High-tech salaries 2,99. High-temperature cell 2,94. High-temperature cell 2,94. High-temperature cell 3,94. High-temperature cell 3,94. High-day charage 3,22.
Fun	ne-hood design damental knowledge	10,50. 2,120:	Hypres Inc. 10,76.
Fus	ion reactor	2,120; 10,13. 2,78. 9,28.	Idaho Nati Engg. Lab
G-V. GaAN Gaill Gala Galli Gard Gard Gard Gard Gard Gard Gard Gard	turbine engine Title Ectric Co. Title Ec	9,48. 1,61. 10,34. 7,97. 6,76. 10,91. 5,33. 10,95. 3,31. 1,35. 4,35. 5,38. 4,35. 7,75. 7,75. 4,47. 7,72. 7,75. 8,28. 8,14.	10.80,83,92,103 Image analysis 3,29,5,52 Image compression ratios 3,27 Imagin polarimeter 5,50 Indiana Univ. Indiana 5,68 Indiana Univ. Indiana 5,68 Indiana Univ. Indiana 5,68 Indiana Univ. Indiana Univ. Indiana In

INDEX TO VOL. 30 (1988)

invention disclosures 11,22.	Large-mission R&D 6,63.	Magnetic field probe 18,87.
inverse levitation 9,24.	Lasentec 10,66.	Magnetic materials 5,39.
inverse temp. transition 8,57.		Magnetic resonance image 4,36;
on Beam Applications SA 10,100.	Laser displacement sensor 9,187.	11,85.
on beam irradiation 10,109.		Magnetic-field noise 6,80.
on chromatography 9,92.	Laser interferometer 10,87.	Magnon-pairing mech. 11,21.
on configuration 9,44.	Laser photolysis 1,29.	Management crisis 3,25; 9,139.
on implantation 4,35.	Laser radiation 6,39; 10,26.	Managing innovation 8,13.
on lasers 10,100.	Laser-based welding syst. 10,24.	Manifolded MCFC stack 7,3.
on-mobility spectrometer 8,50.	Laser-flash method 7,22.	Manned missions 1,33; 2,50;
onization vacuum gage 7,63.	Lasers & Electro-optics 3,31.	8,20.
onizing radiation 3,47.	Lattice gas algorithm 10,74.	Manned space station 1,33; 7,54.
ron carbonyls 4,15.	Launch policy 10,3.	Manned voyage to Mars 7,20.
rradiation process 4,36.	Launch systems 8,20; 9,28.	Manufacturing Research Center
soconductive gradient 9,92.	Lawrence Awards 10,3.	3,31.
somers 9,82.	Lawrence Berkeley National Lab	Market niches 1,9.
sraeli researchers 7,3.	10,84.	Market research 4,27; 11,48.
STEC 11,81.	Lawrence Livermore National Lab	Mars dust 4,15.
	10,63,66,76,79,91,99,100.	Mars time 3,15.
	Leaching nuclear wastes 4,36.	Martian gravity 9,28.
	Lead users 8,13.	Martian missions 2,50.
Japan Spectroscopic Co. 10,87.	Legislative changes 7,21.	Martin Marietta Energy Systems
Japanese patenters 6,17.	Levitation 5,46; 9,24.	4,74.
Japanese technology 2,43; 6,17.	Leybold AG 10,68.	Mass of a neutrino 7,21.
Joint production venture 6,17.	Liberty Technology Center 10.96.	Mass resolution 9,120.
Joint research ventures 6.63:	Library awareness 6,33; 7,25.	Mass spectrometry 1,44.
7,15.	Light-beam computer 8.27.	Massive parallelism 9,56.
Joint ventures 2,43; 5,45; 8,18.	Lightpipe interface 9.82.	Mc2 10,99.
Jomar Systems Inc 10,75.	Lightweight mirrors 10.3.	McCall, Gene H. 10,3.
Jones, Robert R. 6,23.	Lignite systems 1,41.	Median salaries 3,57; 5,78.
Josephson effect 1.34.	Liquid sampling 11.88.	Medical laser systems 8,14.
Kenaf newsprint process 10.92.	Liu, Chain T. 10.3.	Meisner effect 1.34: 9.24.
Kevex Corp 18,104.	Localized deposition 4.99.	Membrane permeation 4,49.
Killer bees 8,121.	Lockheed Aeronautical 10,83.	Metal matrix composite 10,83.
"Kryptogen" lamp 18.5.	Loctite Corp 18.84.	Metal pollutants 4,31.
Kublai Khan 9.63.	Long-wavelength infrared 10,109.	Metallic particles 1,54.
	Los Alamos National Lab	"Metapericolor" 3,29.
1	10,73,74,75,80,95,96,99,104.	Methane atmosphere 3,43.
L	Low-angle-thrust fault 1,35.	
Lab module \$,68; 7,27.	Low-intensity objects 10,109.	
Laboratory of the Year 1,39;	Low-temperature deposition 1,61.	Micro-structure analysis 10,87.
5,3,68; 11,27; 12,25.	Lunar robot 4.36.	Microchip 4,39; 8,121.
Laboratory workbench software	Luthier 8.33.	Microcircuits 4.27.
3.70.		Microelectronics 2.60; 3.48.
Lahey, Richard T Jr. 10.3.	NA.	MicroESCA 4.31.
Landfill sites 3.29.	IVI	Microgravity experiments 4,41;
Language difficulties 1,13; 3,39.	Magelian spacecraft 12.21.	
Laptop computers 1,13, 3,23.	Magnesium allovs 6,143.	Microlaser 10,103.
Large-angle reflectance 2,94.	Magnet array 5,43.97: 9,47.	Microprocessor 80386 2,3.

gnetic field probe 18,87.	Microscopy 9,112.
gnetic materials 5,39.	Microspheres 4.15.
gnetic resonance image 4.36:	Microstructure analysis 7,5.
11,85.	Microtome for EM 18.67.
gnetic-field noise \$.80.	Microwave amplifier 18,76.
gnon-pairing mech. 11,21.	Microwave center 6,3.
nagement crisis 3,25; 9,139.	Microwave detector 6,34.
naging innovation 8,13.	Microwave processing 1,54.
nitolded MCFC stack 7.3.	Microwave pulses 2,63.
nned missions 1.33; 2.50;	Microwave test equipment 5,29.
8.20.	Midwest Research Institute 10,74.
nned space station 1,33; 7,54.	Midwest Technology Conf. 11,15.
inned voyage to Mars 7,20.	MikroPul Hosokawa Micron Intl
inufacturing Research Center	10.88.
3.31.	Militarization of space 10,22.
rket nieboe 10	Military establishment 1,13.
rket niches 1,9. rket research 4,27; 11,48.	Military vehicle 5.64.
ers dust 4,15.	Micros array 3,29.
ers dust 4,15. ers time 3,15.	Mirror blank 10.3.
artian gravity 9,28.	Mitsubishi Electric Corp 10.87.
rtian missions 2.50.	Mobile spectrometry lab 9,34.
rtin Marietta Energy Systems	Molecular beam epitaxy 1,61.
	Molecular biophysics 10,56.
uss of a neutrino 7,21. uss resolution 9,120.	Molecular modeling 1,43; 2,63.
ass resolution 9,120.	Molecular motions 2,63.
iss spectrometry 1,44.	Molecular rotation state 9.82.
essive parallelism 9,56.	Molecular transition rate 9.82.
2 10.99	
Call, Gene H. 10,3. edian salaries 3,57; 5,78.	
edical laser systems 8,14.	
edical laser systems 8,14. Hisner effect 1,34; 9,24.	
etal matrix composite 10,83. etal pollutants 4,31.	Multipiece molds 3,48.
	Muniple-site damage 8,25.
etallic particles 1,54.	Multipolar microwave ECR 5,97.
tetapericolor" 3,29. ethane atmosphere 3,43.	Myers, R.R. 2,108.
ethane atmosphere 3,43.	
ethane concentrations 3,29.	
cro-machining 4,49.	N I
cro-structure analysis 10,87.	7.
crechip 4,39; 8,121. crocircuits 4,27. croelectronics 2,60; 3,48.	
Crocifcuits 4,27.	NASA 3,114; 6,22; 8,20; 12,20.
croelectronics Z,60, 3,48.	NASA funds 6,22; 10,22; 12,20.
GIUCOUN TOUR.	NASA Lewis Research 18,76,95.
crooravity experiments 4.41:	National Acad. of England 10.3.

National Inst. o	f Standard	Is &
Technology		36: 6.29:
	10,24,75,	
National Institu		
National Medal		
National Science		48 12
		18,13.
National securi	y airective	3,36.
National techno	nogy ponc	y 8,18.
Navajo Indians		11,3
Nd:YAG laser		10,26
Near-infrared to	ansmissio	n 5,112.
Neuro-optic sys	dam	8,47
Neutrino		7,21.
Neutron micros	cone	10.63
Neutron stress	monilor	10,99
Nichols Techno	Innu Conte	5.68
Michal /hudron	ooli	48 70
Nickel/hydroger	1 CON	18,76
Nighttime visib	mey .	7,97
Nobel Prizes		12,22
Noble-gas-dope	ed alloys	10,80
Non-imaging of	otics	5.58
Nonconductive	samples	9,112
Nondefense res		11: 4.39
		7,48
Nondestructive	instrumen	
Nondestructive	manning	5,112
Mandachuclive	trapping	5,92,112
Nondestructive	resumy t	B 04
Manufactulant	anhinar	6,24
Nonelectrical m	acrimiery	4,27
Monlinear field		8,50
Nonmetallic ho	neycumb	7,54 3,35
Not-for-profit c	orporation	3,35
		4,9
Not-invented-h	ere 6.	63: 9,13
Noyce, Robert		9.20
NSF grants		2.45
Nuclear accide	nd	0 24
		B 20 22
Nuclear facilitie		10,22,23
Nuclear interac	tions	9,44
Nuclear materia	er solution	
		10,99
Nuclear science	1	10,3
Nuclear waste		1,27
		- July
	0	
	U	
Oak Ridge Nati	onal Lab	5,68
		10.74
Oak Ridge Y-1		10,104

1,29, 1,67, 1,25, 1,13, 36, 1,36, 1,36, 26, 112, 47, 21,63, 99,58, 1,76, 99,78, 1,28, 1,76, 1,99, 1,18	Offshore petroleum prod. 1,27. Olimic contact 1,61. Oli-free pumps 6,87. 8,69. Optical circuit 8,27. Optical components 8,27. Optical components 9,12. Optical components 9,12. Optical light recorder 1,15. Optical space missions 10,102. Optical display tecorder 1,15. Optical display tecorder 1,15. Optical display tecorder 1,15. Optical display 1,15. Opt
112. 112. 1,24. 1,50. 1,54. 1,35. 4,9. 1,13. 1,20. 1,45. 1,20. 1,44. 1,99. 1,99. 1,99.	Parallel processing 4,63,80. Particle accelerator prizes 12,3. Particle accelerator prizes 12,3. Particle six analysis 1,44, 1,66. Particle six analysis 1,24, 1,66. Penetration microwavas 1,54. Performance evaluations 4,31. Performance evaluations 4,31. Performance projects 1,66. Personal computer 4,77,81. Personal research projects 4,134. Personal research projects 4,134.
1,68; 1,74. 104.	Perturbation fractions Petrochemicals pH sensor Phased product develop. Phobos Phobos Phobos Phobos Phobos Phobos Phobos



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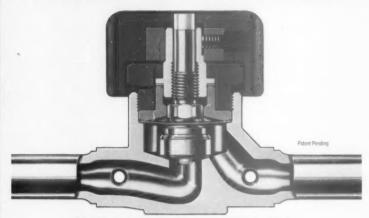
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٦	Phosphoric-acid systems 2,74;	Reaction kinetics 2,67.
1	5,60.	Reaction rate 9,112.
Į	Photoinisctor 18 104	Recombinant DNA 11,72. Reduced productivity 7,11.
ł	Photoluminescence spectroscopy 5,112.	Redundant macrocells 2.60.
1	5,112.	Reflection assumptor 46 90
1	Photon flow rate 9,82. Photonics market 11,21.	Refractory metal 9,52. Refrigerants 11,48.
1	Photovoltaic concentrator 16,153.	Regreening of earth 5,17.
1	Piezoresistive sensing 6.3.	Regreening of earth 5,17. Regulated-bridge Pirani gage 7,63.
ı	Pilot operations 5,68. Pines, Alexander 10,3.	Reinforced metal matrix 10,95. Reinventing the wheel 2,11;
1	Pittsburgh conference 1.29:	10.123.
1		Relaxation theories 2,67.
ı	Planetary missions 9,28.	Remotely piloted vehicle 5,64. Rentzepis, Peter 5,39.
ı	Plastic house 9.187.	Rentzepis, Peter 5,39. Research data processing 2,3.
1	Pluto 3.43 10.3	Research programs 6.29: 11.27.
1	Plutonium 8,23. Polarization synthesis 5,50.	Resistance measurement 5.80.
1	Polarization synthesis 5,50. Polarized energy 5,50.	Resistivity 1,61. Response times 7,63.
1	Polarography 2,126.	Restraints on trade 6.17.
1	Pollutants 1,44; 10,153.	
1	Polytants 1,44; 19,153. Polyester packaging resins 2,29. Polymer blends 7,5.	Retinal neurons 5,47. Retrospective line scan 9,120.
ı		Retinal neurons 5,47. Retrospective line scan 9,120. Robot 2,57; 4,36; 6,3. Robot landers 6,22. Robot station 6,22.
ı	Polymer systems 4,52. Polymer-glass edge coating 10,79. Polypeptide 4,31; 8,57; 10,7,56.	Robol landers 9,28.
1	Polymer-glass edge coating 10,79.	Robot station 6,22. Robot vehicles 7,27.
1	FUSCIUUII PIUJCUI 1,27.	Robotic handling 6,3.
	Positron microscope 3.39: 10.26.	Robotics 1,43; 5,47; 9,47; 12,21. Robots for space 5,48.
	Powder particles 5,65. Power monitors 1,54.	Robots for space 5,48.
	Power monitors 1,54. Power spectrum module 3,70. Pratt & Whitney Aircraft 10,95.	Back abusics 4 CO
	Pratt & Whitney Aircraft 10.95.	Rocket fuel shortage 8,20.
1	Presidential candidates 7,11. Pressure gradients 9,12.	Rocket fuel shortage 8,20. Rocket launcher 6,23. Rubber products 2,133.
	Pressure measurement 7.63.	Rubber products 2,133.
1	Pressure-limiting apertures 9,112. Pressurized stacks 2,76.	S
1	Primary ion pulse 9,120.	Safety engineers 10,50.
	Private US launch industry 4,41.	Salary increases 2.29: 3.57.
	Proactive analysis 7.44	Salary levels 3,57.
	LIOCE22 COLLEGE 1 4-44	Salary survey 8,23,118. SALS devices 9,74.
1	Product development 5.23.68:	SALS devices 9,74. Salt cavern 1,41.
1	7.44: 8.81: 10.44.123: 11.52	Sandia National Labs 10.66
1	Product development cycle 18,44. Productivity 2,73; 3,70;	Satellite monitoring 8,5. Satellites 2,68; 6,23.
4	7.11.18.44; 8.19; 9.20.55.	Satellites of Pluto 3,43.
	Profit goals 1.46.	Scandium anode 11,63.
1	Profits 3,25. Programming language 2,100.	Scanning electron microscope 5,84; 9,112.
1	Protection standards 3.36.	Scanning ion microscope 10.67.
1	Protein R&D 6,143.	Scanning ion microscope 10,67. Scanning thermometer 6,80.
1	Prototype hoods 10,50.	Schizoid robots 5.62.
1	Psec signal processor 10,76. Pulsar 10,28.	Scholarly articles Science adviser 4,45; 10,22.
İ	Pulse analysis 8,27.	Science and technology 9.55; 10,22
1	Pumping chamber 8,69.	Coinnes Applications Inti
1	0	Science Applications Intl 10,96. Science city complex 5,40.
1	u	Science education 10,22.
1	Quadrupole mass analysis 11,95.	Science space missions 8,20. Scientific community 4,45.
ı	Quality Control Institute Inc 10,8R. Quality deficiency 2,120.	Scientific community 4,45. Scientific cooperation 3,36.
i	Quality standards 5.84.	Scientific credibility 4.47
1	Quasi-dc technique 6,80.	Scientific development 7,3. Scientific exchange 3,36.
1	D	Crientific interaction E CO
	R	Scientific leadership 7,44.
1	R&D 100 competition 1,39;	Scientist of the year 10,7,56;
	2,65; 4,74; 5,11; 9,26,44; 10,60,62; 11,29; 12,24.	Scientific leadership 7,44. Scientist of the year 10,7,56; Scaborg, Glenn T 8,23. Scaled mercury electrode 2,126.
1	M&U 2000 committee 3,35; 4,9;	Sealed mercury electrode 2,126.
	9,56,78:	
	6,11; 7,15,18; 11,47. R&D administrators 2,120.	Secondary-imaging detect. 9,112. Seismic activity 1,35.
	R&D budget 4,39: 9,13.	Self-healing superchip 2.60.
	R&D careers 2,120. R&D consortia 6,63.	Semiconductor fabrication 4,35; 10,92
1		Semiconductor R&D 9,20;
	R&D demographics 5,78. R&D funding 2,44; 3,50; 4,40; 5,48; 6,22,29;	11.30.
	5,48; 6,22,29;	Senate Bill 2484 8,11. Sensitive information 6.33
	18,13; 12,16. R&D index 7,15.	Sensitive information 6,33. Sensitivity 8,50; 9,82,92,120;
	R&D index 7,15. R&D industry 3,57; 5,78; 8,11; 11,15. R&D investments 4.40	10,109.
	11,10.	Sensor array
	R&D priorities 1 35- 11 0	Separation processes 8,14. Sepracor Inc. 10,95.
	R&D problems 3.9	Shear moduli 7,54.
	R&D proposals 2,38. R&D salary 3,57.	Short-term goals 2,11,44;
	R&D spending 5,29; 7,18; 8,11;	Separaco mc. Shear moduli 7,54 Short-term goals 2,11,44 3,114 Shotscope computer Shutter-grid pulse 5,50. Shuttle imaging Radar-C 5,50.
	R&D tax credit 2,37; 8,11;	Shutter-grid pulse 8,50.
	R&D tax credit 2,37; 8,11;	Shutter-grid pulse 8,50. Shuttle imaging Radar-C 5,50.
	9,17. R&D tax credit 2,37; 8,11; 10,22. R&T budget 2,44.	Sidereal period 3,15. Siemens Anal X-Ray
	Radiation contamination 1,27.	Instruments 10,103.
	Barbation barebase 1.61	Silicon carbide ceramic 10,83.
	Radiation output 10,5. Radiation-scattering 9,74.	Silicon technology 4,49. Silicon-based sensors 4,49.
	Hadiation-to-light conv. 10,/6.	Silicon-budroppe allow 4 50
	Radio-frequency waves 6.3.	SRMS spectrometer 10,62.
	Radioactive trace analysis 2,126. Radioisotope production 10,100.	
	Railguns 3,48.	Single-column ion chromatography 9.92.
	Rate of growth of R&D 9,17.	Single-machine process 0,143.
	Reaction on 8,50.	Sixth force 2,68.

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For information circle 173

Research & Development, December 1988 81



For information circle 174

INDEX TO VOL. 30 (1988)

Size and charge analyzer 10,88. Slow relaxation theory 2,67.	Spectral analysis software 10,75.	Surface composition 9,120.
	Spectral reproducibility 9,82.	Surface-sensitive method 10,26.
Sludge-to-oil reactor 10,92.	Spectremeter for neutrino study	Switched-field technique 8,50.
Small businesses 4,47; 6,29;	7,21.	Synaptic pathways 7,35.
8,11.	Spectroscopic analyses 4,31.	Synchrotron radiation 4,31.
Small comets 6,34.	Spectrum analyzers 5,29.	Synchrotron x-ray source 9,47.
Small-angle light scattering 9,74.	Specular reflectance 2,94.	Synthetic proteins 11,72.
SNMS/SIMS module 10,68.	Spinning cup atomization 5,65.	Systems Control Tech. 10,95.
Soft x-ray microscope 10,26.	Start-up companies 4,74; 8,11.	_
Seft x-ray monochromater 10,103.	Static recrystallization 7,22.	T
Soft-start roughing 6,87.	Steam generators 4,36,52.	
Software protection 2,100;	Stellar physics 3,43.	Takeoff monitoring system 9,26.
14,33.	Step-scan for FTIR	Tandem cell concept 4,50.
Solar cell 4,50; 12,3.	spectrameters 19,68.	Tax credit 7,11; 8,11; 9,13.
Sutar energy 5,58; 7,97; 10,153.	Stepper motor controller 10,75.	Technical libraries 6,33; 7,25.
Solgel study 9.43.	Stereomicroscopes 2,88.	Technological competition 2,44;
Solid modeling 18,44.	Sticking probability 10,109.	11,46.
Solid-electrolyte system 9,43.	Stock market drop 1,46.	Technological development 3,25.
Solid-fuel propellants 6,23.	Strain gage sensors 2,57; 9,3.	Technological innovation 2,25.
Solid-oxide designs 2,74.	Stray-light analyzer 7,97.	Technological leadership 3,9; 7,11;
Solid-rocket booster 1,33.	Structure of rock 4,68.	9,17.
Sorption pumps 6,87.	Subatomic particle 7,21.	Technology base 2,44; 3,114.
Southtech Inc. 10,83.	Submicroscopic particles 1,44.	Technology transfer 4,47,74;
Soviet cosmonaut 2,50.	Subsonic vibrations 5,33.	5,40,45; 6,3,63; 9,13.
Soviet intelligence 7,25.	Successful products 8,81; 11,46.	Telescope technology 4,42.
Soviet scientists 3,36.	Sulfur-eating bacteria 1,29.	Temperature transition 8.57.
Soviet Union 9,28,55.	Sun's hydrogen halo 6,34.	
Space exploration 2,44; 9,28. Space platform 4,41.	Sun 5,58; 11,30,43. Superallovs 4.52.	Thermal conductivity 1,61; 7,63. Thermal diffusivity 7,22.
		Thermal expansion 7,54
Space probe 6,22; 8,20.	Supercomputer 2,43; 4,63,70; 5,47; 9,56; 12,3.	Thermal FFF separator 10,66
Space programs 1,34: 6,22:	Superconducting behavior 1,34.	Thermal stratification 3.62
7,27; 9.28; 10,3.22.	Superconducting cable 5,39.	Thermal-plume interaction 3,62
Space science 1.33: 3.48:	Superconducting callider 2.68:	Thermal-voltage errors 6,80
8,121.	7.20.	Thermodynamic data 9,98
Space shuttle 1,33: 6,22: 8,20:	Superconducting fibers 7.29.	Thermodynamic properties 10,44
9.28	Superconducting magnet 4,31.	Thermoelasticity 8.57
Space shuttle astronauts 10,153.	Superconducting oxides 10.23.	Thermogravimetric analysis 2,133
Space station 2,48; 5,62;	Superconductivity 1,35; 3,47;	5.54
7.20.27; 10.3.22,153.	4.27.135:	Thermomechanical process 7.22
Space station assembly 2.59.	5,46; 9,25; 10,22; 11,81.	Thermosetting resin \$.33,65
Space technologies 2.44	Superconductivity center 6.3.	Thickness/composition
Space telescope 8.20.	Superconductor 1,3,27:	measurement 6,143
Space-hardened component	4,52; 5,46; 5,39; 6,80;	Thin delectric litms 4,99
10,153.	9.24: 11.20: 12.3.	Thin-film oxygen sensor 10,88
Spacecraft 3.48; 7.97.	Supernova 8.121.	Thin-film Si/H alloy 4,50
Spatial resolution 4,31; 5,92;	Superplastic conditions 7,22.	Three-legged robot 4,36
9,120; 16,109.	Supersonic transport 6,17.	Time-of-flight sensors 8,50
Specialty polymers 8,14.	Surface analysis 2,37; 9,120.	Titan probe 6,22

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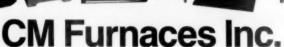


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ToFSIMS instruments 9,120. Toshiba Corp 5,45.	X-ray microprobe/scope 10,104. X-ray microscope 10,66.
TOXIC-gas detector 9,31.	X-ray photo-electron
Toyota Central R&D Labs 10,88,95.	x-ray spectrometer 5,39; 11,62.
Trace measurement system 10,75.	X-ray tube 11,63.
Trace metal analysis 2,126. Tracer-gas technology 10,50.	Zenith Flectronics Corn 10 75
Tracking systems 8,5.	Zinc injection passivation 10,95. Zinc penetration 5,84.
Tracor Northern Inc. 10,66. Trade deficit 1,46; 2,116; 4,27.	200m Stereumicroscopes 2.66.
Trade deficit 1,46; 2,116, 4,27. Trade policies 2,43; 6,31. Transatmospheric vehicle 7,54.	Zygo Corp 10,63,87.
Transition temp. 5,46; 9,24.	AUTHORS
Transmission electron microscope 5,84.	Agres, Yed 1,33; 2,44; 3,36; 4,41; 5,45; 6,31; 7,20; 8,18; 9,30; 10,22; 11,21; 12,20. Anderson, David 3,25.
Transmission mode 2,94.	5,45; 6,31; 7,20; 8,18;
Transparent single-phase flow 3,62.	9,30; 10,22; 11,21; 12,20. Anderson, David 3,25.
Transputers 5,47. Transuranium elements 8,23	Ranhy John 3.62
Transverse-impulse vib. 9,187.	Bellman, Robert A. Jr. 2,100.
Trapping field 8,50. Tungsten, high-purity 10,80.	Bivas, A. 5,112. Blanchard, William C. 8.50.
Tungsten, high-purity 10,80. Tunneling microscope 2,37. Turbomolecular vacuum pump	Blanchard, William C. 8,50. Blessing, James E. 11,95. Brar, A.S. 5,84.
3,/5.	Caren. Stuart 10.44.
Two-step laser process 6,39.	Cassidy, Robert 8,13; 9,20; 10,13; 11,15,80.
U	Chen. H.7. 1.61
	Chenery, D. 11,88. Cole, Beth 4,99.
7,21.	Cooke, Mike 5,97.
U.S. industry 1,9; 6,11.	Danielson, Phil 6,87.
U.S. markets 4,127. U.S. patents 6,17.	Derra, Skip 1,54; 2,53; 3,37; 7,21,54;
U.S. patents 6,17. U.S. R&D industry 7,11. U.S. scientists 3,36.	8,23; 9,24; 10,24.
U.S. scientists 3,36. U.S. technology 2,11,43; 3,9; 4,9;	Corriar, Andrew 4,86. Danielson, Phil Derra, Skip 1,34; 2,53; 3,37; 7,21,54; Dinneen, Gerald P. Dinneen, Gerald P. Danielson, W.P. Frand, Erwin A. 1,19; 2,25; 3,24; 4,23; 5,23; 6,103; 7,75; 8,81;
U.S. technology 2,11,43; 3,9; 4,9; 6,11; 8,11. Ube industries Ltd. 10,95.	Frand, Erwin A. 1,19; 2,25; 3,21; 4,23; 5,23; 6,103; 7,75; 8,81; 9,139; 10,123; 11,107; 12,57 George, Patricia 10,109 Groves, lan 2,133
UK science budget 5,45.	9,139; 10,123; 11,107; 12,57.
Ultrafast chips 6,40. Ultrahigh-speed integrated	George, Patricia 10,109. Groves, Ian 2,133.
circuit 5.92	Groves, Ian 2,133. Gwynne, Peter 2,50; 3,43; 4,42; 5,45; 7,21; 11,20; 12,22. Hallewell, G.D. 9,98.
Ultrahigh-vacuum operation 7,63. Ultrasonic range-finding 9,98. Ultrawiolet light 12,24.	Hallewell, G.D. 9,98.
Uniform coal samples 12,24.	Harniman, Richard J. 9,112. Harrington, H.W. 9,82.
Uniform coal samples 1,41. University education 2,120. University libraries 7,25.	Hart M A 9.82
University libraries 7,25. University researchers 5,68.	Haydon, Edwin 1,35; 4,39; 5,47. Heffwig, Helmut 7,44. Jandik, P. 9,92. Jones Robert R. 1,9; 2,11;
University-small business 1,37.	Jandik, P. 9,92.
University researchers 5,68. University-small business 1,37. Unmanned space platform 7,27. Unmanned spacecraft 9,28.	Jones Robert R. 1,9; 2,11; 3,9,35,57; 4,9,42,74; 5,11,78; 6,11; 7,11; 8,13; 18,7,56; 11,9; 12,11
Urry, Dan W. 10,7,56. Utility industry 4,52. UV aurora imaging 6,34.	4,9,42,74; 5,11,78; 6,11; 7,11; 8 11: 9 13: 10 7 56: 11 9: 12 11
UV aurora imaging 6,34.	Jones, W.R. 9,92.
UV-curing silicone 10,84.	3,15; 4,15; 5,17; 6,49; 7,35;
V	Jones, W.R. 9,92. Jueneman, Frederic B. 1,13; 2,19; 3,15; 4,15; 5,17; 6,49; 7,35; 8,33; 9,63; 11,43; 12,33. Kahn, Herbert L. 2,116.
Vacuum chamber 6,87; 9,5; 11,95.	
Vacuum microelectronics 8,121.	Leibrand, R.J. 9082.
Vacuum-based operation 8,69. Vacuum-TGA 2,133.	Mattson, Brad 4,99. Maziarski, Leonard 2,88.
Vannevar Bush Award 8.23.	
Varian Associates Inc 10,76. Venus 12,21.	Milward, R. 11,88. Morkoc, H. 1,61.
VG lonex Ltd. 10,62. Violin making 8,33.	Mosbacher, C.J. 1,46: 4,92.
VLIW computer 4,80.	U'Donnell, John J. 4,80.
Vollum Institute 5,68. Wortex breakdown 4,70.	Uras, J.J. 3.62.
144	Parr. Gary 1 #1.69: 9.105.
Water	Paslaski, J. 1,61. Pelster, William 6,80. Powell, R.A. 5,112.
Wafer maps 5,112. Wafer uniformity 4,99.	Powell, R.A. 5,112. Putnam, F.A. 6,68.
Wall, Joseph S. 10,3. Wave motion 9,187.	
Wave propagation 2,59.	Richardson, C.H. 9,120. Rosenau, M.D. 11,52. Rossiter, Val 2,94; 11,88.
Waveguide 1,54. Waveguide dosimeter 10,96.	Receitor Val 2 Qui 11 RR
Wear pattern 5,84.	I Scholes, William A. 3,50: 11,25.
Weldable aluminum alloy 10.84	Smith, Dirk A.D. 7,58.
Wide-field-of-view system 10,91 Wind power 9,50 Wind turbine generator 9,50	Stambler, Irwin 2,48,67; 3,41; 4,70; 5,47; 6,34; 7,54; 5,30,32; 11,20,25.
Wind turbine generator 9,50.	1,30,32; 11,20,25.
Windshield wear 7,97.	Studt, Ithouny G. 2,02.
Working conditions 2,120.	Thomas, H.I. 2,108,120: 5,68.
Working conditions 2,120 Workplace productivity 7,11 Workplaces 5,164	Thomas, Leonard C. 2,133. Urry, Dan W. 8,56; 11,72.
1	Volbert, B. 11,62
X-Y-Z	Walls, J.M. 9,120. Wetzier, Fred 5,92
X-probe "MicroESCA" 4,31. X-ray beam 10,26.	Wetzier, Fred 5,92 Willcox, David 6,76 Wilson, Mark 7,63
X-ray bone densitometer 10.73.	Wilson, Mark 7,63 Wolfe, R. 12,40
X-ray detector 10,104 X-ray diffraction 9,74	Wyrick, Larry 7,58
X-ray fluorescence 6,143	Voriu A 161
X-ray lithography 12,85	3,47; 4,40; 5,48; 9,25; 11,30
X-ray micro-diffractometer 18,103	Zboralski, Jon 10,51

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